18-Bit Switchable Active SCSI Bus Terminator (110 Ω)

The MCCS142235[™] is a precision 18-bit switchable active SCSI bus terminator. It is used in conjunction with a 2.85V regulator (MC34268). Also provided is a Local-V_{CC} (LV_{CC}) low voltage sense circuit to latch the enable state when a peripheral is shut down or loses power. When the device is enabled according to the truth table below, the MCCS142235 provides 110Ω precision resistor pull-ups to a 2.85V reference for termination of 18-bits in a SCSI standard bus system interface. When the switch is disabled, the device is in a High Impedance State on all 18 bits.

The low voltage sense circuit gives the device the ability to latch the current output state when power is removed from the LV_{CC} pin. As long as TERMPWR remains, there is no interruption to the SCSI bus when powering down a SCSI peripheral, because the proper termination condition remains.

In 8-bit SCSI applications ("A" cable), only one '2235 is needed at each end of the SCSI cable in order to terminate the 18 active signal lines. In 16-bit WIDE SCSI applications ("P" cable), one '2235 and one '2234 (or two '2235s) would be needed at each end of the SCSI cable in order to terminate the 27 active signal lines.

For information on "Power Dissipation for Active SCSI Terminators," refer to ON Semiconductor Application Note AN1408/D, available through the ON Semiconductor Fax System, or through the ON Semiconductor Literature Distribution Center.

- Complies With SCSI and SCSI-2 Standards
- 18 Switchable 110Ω Terminating Resistors
- Operating Temperature Range: 0°C to 70°C
- Operating Voltage Range: 2.75 to 2.95V
- Resistor Tolerance ±5.0% (Over Temperature and Supply Voltage Ranges)

TRUTH TABLE

• Local–V_{CC} (LV_{CC}) Low Voltage Sense Circuit

			Т	est	E	nable	9	C	Output	:		
	Acti	ive		0		0			Ζ			
	Mo	de		0		1		Terminated				
	Te: Mo	st de		1		х		Те	st Moo	le		
VREC	G LV _{CC} 23	018	017 21	016 20	015 19	014 18	013 17	012 16	011	010 14	Tes	t
	MCCS142235											
1	2	3	4	5	6	7	8	9	10	11	12	Т
V _{ref}	Enable	01	02	03	04	05	06	07	08	09	GNI	D
		Fi	aure	1 24-	l ead	Pino	ut (T	on Vie	w/)			

Figure 1. 24–Lead Pinout (Top View)

MCCS142235

18–BIT ACTIVE SCSI TERMINATOR **(110**Ω**)**



DW SUFFIX 24-LEAD WIDE SOIC PACKAGE CASE 751E-04



FA SUFFIX 32-LEAD PLASTIC FQFP PACKAGE CASE 873A-02











*For More Application Information Refer to the MC34268 Datasheet.



MAXIMUM RATINGS*

Symbol	Parameter	Value	Units
VREG	DC Regulated Power Voltage (Referenced to GND)	-0.5 to 3.0	V
V _{in}	DC Input Voltage (Referenced to GND) for Test/V _{ref} pins	- 0.5 to VREG + 0.5	V
V _{in}	DC Input Voltage (Referenced to GND) for LV_{CC} /Enable pins	– 0.5 to + 6.0	V
V _{out}	DC Output Voltage (Referenced to GND)	- 0.5 to VREG +0.5	V
l _{in}	DC Input Current, per pin	± 20	mA
l _{out}	DC Output Current, per pin	± 35	mA
I _{CC}	DC Supply Current, VREG and GND pins	± 500	mA
T _{stg}	Storage Temperature	– 65 to + 150	°C
TL	Lead Temperature, 1mm from case for 10 seconds	260	°C

* Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

RECOMMENDED OPERATING CONDITIONS

Symbol	Symbol Parameter		Max	Units
VREG	DC Regulated Power Voltage (Referenced to GND)	2.75	2.95	V
V _{in} , V _{out}	DC Input Voltage (Test/V _{ref} Inputs)	0	VREG	V
V _{in}	DC Input Voltage (Enable, LV _{CC} Inputs)	0	5.5	V
T _A	Operating Temperature	0	70	°C
t _r , t _f	Input Rise and Fall Time (All inputs but $\mathrm{LV}_{\mathrm{CC})}$	0	500	ns
t _r , t _f	Input Rise and Fall Time (LV _{CC)}	0	no limit	ns

DC CHARACTERISTICS

		VREG	25	°C	0°C to	0°C to + 70°C		
Symbol	Parameters	(V)	Min	Max	Min	Max	Unit	Condition
V _{IH}	Min High–Level Input Voltage	2.85	2.0		2.0		V	Per Truth Table
V _{IL}	Max Low–Level Input Voltage	2.85		0.8		0.8	V	Per Truth Table
l _{in}	Max Input Leakage Current (Enable Input)	2.85		±0.10		±1.0	μΑ	V _{in} = GND
	Max Input Leakage Current (Test Input)	2.85		±0.10		±1.0	μΑ	V _{in} = GND
	Max Input Leakage Current (LV _{CC} Input)	2.85		±0.10		±1.0	μΑ	V _{in} = GND V _{ref} = GND
		2.85		±100		±200	μΑ	V _{in} = 5.5V V _{ref} = GND
	Max Input Leakage Current (V _{ref} Input)	2.85		±0.10		±1.0	μΑ	V _{in} = VREG LV _{CC} = VREG
I _{OZ}	Max Output Leakage Current	2.85		±0.50		±5.0	μΑ	Per Truth Table V _{out} = GND or VREG
I _{CC}	Max Quiescent Supply Current	2.85		1.0		10	μΑ	V _{ref} /LV _{CC} = VREG Enable/Test = GND
	Max Quiescent Supply Current (Comparator Active)	2.85		100		200	μA	Enable/V _{ref} /Test = GND LV _{CC} = 5.0V
	Max Quiescent Supply Current (Comparator Active/ Termination Active)	2.85		800		1000	μA	Test/V _{ref} = GND Enable/LV _{CC} = 5.0V $I_{out} = 0\mu A$

TERMINATION RESISTOR CHARACTERISTICS

		VREG (V)		35°C		0°C to + 70°C			
Symbol	Parameters	Min	Max	Min	Мах	Min	Max	Unit	Condition
R110	Output Termination Impedance (Note 1.)	2.75	2.95	108.9 (Note 1.)	111.1 (Note 1.)	104.5	115.5	Ω	Per Truth Table

1. See Figure 5, Termination resistance versus regulated supply voltage and temperature. 110 Ω Resistor Target Is at 35°C. Temperature coefficient of resistance T_C = 0.135 Ω /°C typical.



Figure 5. Termination Resistance R110 (Ω) versus Regulated Supply Voltage VREG (V) and Temperature (°C) (Model Adj R–Sq = 0.9995)

DC CHARACTERISTICS

Symbol	Parameter	VREG (V)	Typical @ +25°C	Unit	Condition
VT	Latch Voltage (LV _{CC} Input)	2.85	3.70	V	Per Truth Table
Cout	Output Capacitance High Impedance	2.85	8.0	pF	Per Truth Table, Output = 0V



Figure 6. Output Impedance Model

AC CHARACTERISTICS (VREG = 2.85, C_L = 50 pF, t_r = t_f = 6 ns)

Symbol	Parameters	0°C to + 70°C	Unit	Condition
t _(Enable)	Max Propagation Delay, High Impedance to Termination, Enable to Outputs	100	μs	Per Truth Table
t _(Disable)	Max Propagation Delay, Termination to High Impedance, Enable to Outputs	1.0	μs	Per Truth Table

TIMING REQUIREMENTS (VREG = 2.85, $C_L = 50 \text{ pF}$, $t_r = t_f = 6 \text{ ns}$)

Symbol	Parameters	25°C	0°C to + 70°C	Unit	Condition
t _{setup}	Min Setup Time, LV_{CC} to Enable	200	500	ns	(See Figure 7)
t _{hold}	Min Hold Time, LV_{CC} to Enable	50	100	ns	(See Figure 7)



 * If LV_{CC} Enable is grounded then the LV_{CC} feature is disabled.

Figure 7. Timing Requirements

MCCS142235 Applications Information

Proper Use of the LV_{CC} Feature

The ON Semiconductor Active SCSI Terminator chip incorporates features not available in competitor designs. A primary feature, known as "Local V_{CC} sensing", facilitates future migration to reliable software control of the termination state (either terminated or high impedance). When the Enable pin is driven by internal logic within the SCSI peripheral, it is essential that the peripheral be powered up. Otherwise the enable signal to the termination chip may be invalid causing system bus failure due to improper termination. Imagine a SCSI system with a disk drive at one end of the bus which is providing termination to the bus via the MCCS142235 device. A "smart" drive will be providing an enable signal to the termination chip through internal logic circuitry to ensure termination is present. In the event this same disk drive is powered down by a user while the bus is active, what becomes of the termination located within that drive? Does it remain terminated? Does it change state causing the system to crash? Or does it go into an undetermined state?

The termination power supply is always present on an operating SCSI bus through the dedicated TERMPWR line. But the "Local V_{CC} " power supply within each peripheral may be powered down at any time while the SCSI bus is in operation. It is this local supply which powers the peripheral's logic chips and provides the enable signal to the SCSI terminator chip. Therefore, it is essential to maintain the proper enable signal to the switchable terminator even during peripheral power down.

To avoid rendering the system inoperable while powering down a terminating peripheral, ON Semiconductor has an exclusive "Local V_{CC} sensing" circuit on the MCCS142235 which latches the enable state of the termination permanently during peripheral power loss. A comparator within the MCCS142235 can be connected to the local

power supply via the LV_{CC} input. The LV_{CC} level is monitored against an internal reference, and the current enable state is latched should LV_{CC} drop below a predetermined value (≈ 3.70 V). This comparator threshold is set sufficiently high to ensure that a valid logic state still exists on the TTL–level Enable pin prior to latching. Upon return of the local power supply, the enable path automatically becomes transparent, and the termination state returns to system control!

The Local V_{CC} sensing feature has been designed to draw as little DC current as possible. Flexibility has been designed

into the MCCS142235 to allow the Local V_{CC} sensing feature to be disabled when not required. In this disabled state, the DC bias current is completely removed and the enable latch remains transparent at all times.

Figure 8 shows the recommended connection scheme to utilize the LV_{CC} latch feature. Figure 9 shows the recommended connection scheme for applications in which the LV_{CC} feature is not required – the LV_{CC} and V_{ref} pins are shorted to VREG and the enable path remains permanently transparent.



Figure 8. Recommended Connection Scheme to Utilize LV_{CC} Feature



Figure 9. Recommended Connection Scheme to Disable $\mathrm{LV}_{\mathrm{CC}}$ Feature

Enable Input Application	Result	
A. No Connection to Enable		Enable input will be pulled "LOW" internally. Termination will be disabled causing all outputs to be high impedance.
B. Single Pole Switch to Supply		Enable input will be pulled "LOW" internally when the switch is open. Enable input will be held "HIGH" when the switch is closed. The supply source in this case could be TERMPWR, VREG or V_{CC} .
C. Double Pole Switch Between Supply and GND		This is a more expensive way to accomplish application B. above. It is more economical to allow the internal pulldown to provide the "LOW" input level. The Supply Source in this case could be TERMPWR, VREG or V_{CC} .
D. Hardwired "Low"		The MCCS142235 will be permanently disabled causing all outputs to be high impedance.
E. Hardwired "High"		The MCCS142235 will be permanently enabled providing 110Ω nominal impedance to each bus line.
F. External Logic Driven		With LV_{CC} input connected to the local power supply and V_{ref} connected to GND, the Local– V_{CC} sensing and Enable latching feature will be active. If this feature is not desired, tie LV_{CC} and V_{ref} to VREG (per Figure 9), and the Enable state will follow the Truth Table.

PACKAGE DIMENSIONS

FA SUFFIX FQFP PACKAGE CASE 873A-02 **ISSUE A**





R

K

Х

Q

0.250 (0.010) gauge plane

8X M

w

DETAIL AD

Ε С

н





NOTES:

Ζ

T-U

AC

3 (0.008)

0.20 (

 \oplus

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
- DATUM PLANE AB- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT
- THE BOTTOM OF THE PARTING LINE.
 4. DATUMS -T-, -U-, AND -Z- TO BE DETERMINED AT DATUM PLANE -AB-.
 5. DIMENSIONS S AND V TO BE DETERMINED AT
- DIMENSIONS 3 AND V TO BE DETERMINED AT SEATING PLANE AC-.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.250 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-.
- 7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED
- 0.520 (0.020). 8. MINIMUM SOLDER PLATE THICKNESS SHALL BE
- 0.0076 (0.0003). 9. EXACT SHAPE OF EACH CORNER MAY VARY FROM DEPICTION.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	7.000	BSC	0.276 BSC		
A1	3.500	BSC	0.138	BSC	
В	7.000	BSC	0.276	BSC	
B1	3.500	BSC	0.138	BSC	
C	1.400	1.600	0.055	0.063	
D	0.300	0.450	0.012	0.018	
Ε	1.350	1.450	0.053	0.057	
F	0.300	0.400	0.012	0.016	
G	0.800	BSC	0.031 BSC		
Н	0.050	0.150	0.002	0.006	
J	0.090	0.200	0.004	0.008	
K	0.500	0.700	0.020	0.028	
М	12°	REF	12° REF		
Ν	0.090	0.160	0.004	0.006	
Ρ	0.400	BSC	0.016 BSC		
Q	1°	5°	1°	5°	
R	0.150	0.250	0.006	0.010	
S	9.000	BSC	0.354 BSC		
S1	4.500	BSC	0.177 BSC		
V	9.000 BSC		0.354 BSC		
V1	4.500	BSC	0.177 BSC		
W	0.200	REF	0.008	REF	
X	1.000	REF	0.039 REF		

9

PACKAGE DIMENSIONS

DW SUFFIX SOIC PACKAGE CASE 751E-04 ISSUE E



- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) DED SIDE

- MAXIMUM WOLD PROTRUSION 0.15 (0.006) PER SIDE.
 DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	15.25	15.54	0.601	0.612	
В	7.40	7.60	0.292	0.299	
С	2.35	2.65	0.093	0.104	
D	0.35	0.49	0.014	0.019	
F	0.41	0.90	0.016	0.035	
G	1.27	BSC	0.050 BSC		
ſ	0.23	0.32	0.009	0.013	
Κ	0.13	0.29	0.005	0.011	
М	0 °	8°	0 °	8°	
Ρ	10.05	10.55	0.395	0.415	
R	0.25	0.75	0.010	0.029	

<u>Notes</u>

ON Semiconductor and without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

PUBLICATION ORDERING INFORMATION

Literature Fulfillment:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: ONlit@hibbertco.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

JAPAN: ON Semiconductor, Japan Customer Focus Center 4–32–1 Nishi–Gotanda, Shinagawa–ku, Tokyo, Japan 141–0031 Phone: 81–3–5740–2700 Email: r14525@onsemi.com

ON Semiconductor Website: http://onsemi.com

For additional information, please contact your local Sales Representative.